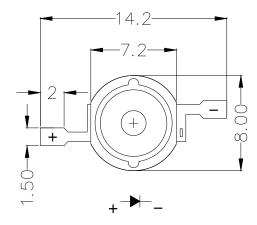
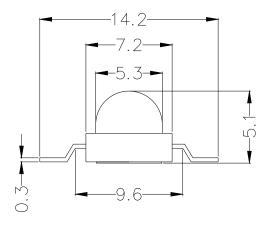
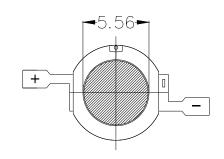
Approval Sheet

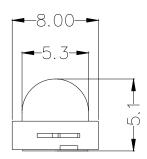
Customer:
Item: High Power LED – 1 W
Part No.: WLW28-140-XX1-Px
Customer P/N:
Customer Approval

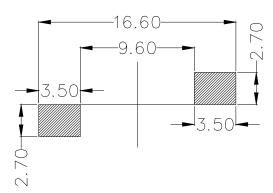
PACKAGE DIMENSIONS











Note:

- 1. All Dimensions are in millimeters
- 2. Tolerance is ± 0.25 mm (0.010") Unless otherwise specified.

Device Selection Guide

Material	Emitting Color	Lens Type	
	White	Water Clear	

Absolute Maximum Ratings at Ta=25 ℃

Parameter	Symbol	Max	Unit	
Power Dissipation	P _D	1.2	W	
Peak Forward Current 1/10 Duty Cycle,0.1ms Pulse Width	I _{FP}	500	mA	
Continuous Forward Current	I _F	350	mA	
Reverse Voltage	V _R	5	V	
ESD Sensitivity	ESD	2000	V	
Operating Temperature Range	Topr	-40°C to+80°C		
Storage Temperature Range	Tstg	-25℃ to+100℃		

Electrical Optical Characteristics at Ta=25 ℃

Parameter	Symbol	Min	Тур	Max	Unit	Condition
Forward Voltage	VF	3.0		3.6	٧	IF=350mA
luminous flux	IV	70	80		lm	IF=350mA
Dominant Wavelength	λd				nm	IF=350mA
Temperature Color	CCT	5650		7000	nm	IF=350mA
Reverse Current	IR			10	μA	IF=350mA
Viewing Angle	201/2		120		deg	IF=350mA

Note.

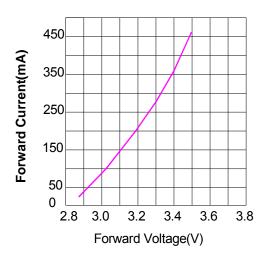
- 1. 201/2 is the off axis angle from lamp centerline where the luminous intensity is 1/2 of the peak value.
 - 2. View angle tolerance is ± 10

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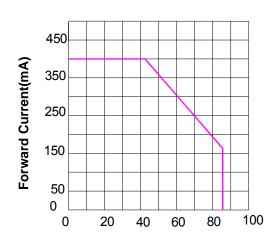
PAGE: 3/9 CHECKED:

Typical Electro-Optical Characteristics Curves

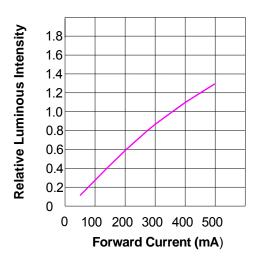
Relative Luminous Intensity vs Forward Current, $T_{Ambient}$ =250 C



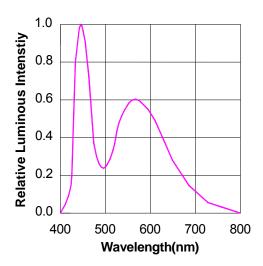
Forward Current Derating Curve, Derating based on Tjmax=125° C



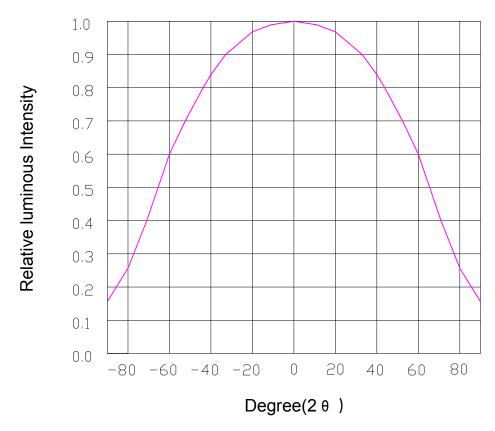
Relative Luminous Intensity vs Forward Current, *T Ambient*=250 C



Relative Spectral Distribution, IF=350mA, T Ambient=25o C



Typical Representative Spatial Radiation Pattern



Note.

- 1. 201/2 is the off axis angle from lamp centerline where the luminous intensity is 1/2 of the peak value.
- 2. View angle tolerance is ± 10

Luminous Flux Bin Table (Im at 350mA)

BIN	LI	Lh	Li	Lj
Luminous Flux	50-60	60-70	70-80	80-90
BIN	Lk	LI	Lm	Ln
Luminous Flux	90-100	100-110	110-120	120-130

^{*}Measure Uncertainty of Luminous Intensity:±10%

Forward Voltage Combination(V at 350mA)

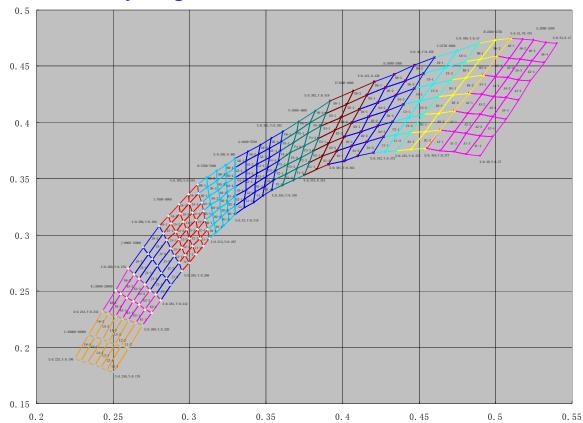
BIN	S	Т	U	V
Forward Voltage	3.0-3.2	3.2-3.4	3.4-3.6	3.6-3.8

^{*}Measure Uncertainty of Forward Voltage:±0.1V

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PAGE: 5/9 CHECKED:





Color Bin (IF=350mA,Ta=25°C)

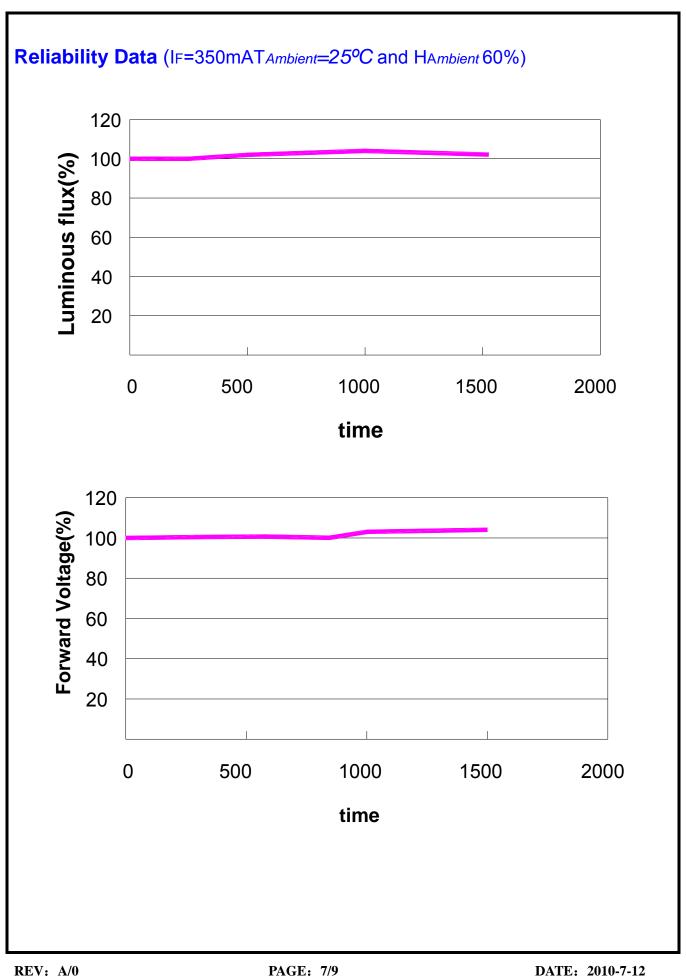
	51 Bit (11 00011/1,14 20 0)										
BIN	CIE			BIN			CIE				
^	X 0.454 0.510 0.540 0.490	0	Х	0.330	0.330	0.361	0.354				
A)	Υ	0.377	0.475	0.470	0.370	G	Υ	0.318	0.368	0.392	0.340
Б	Х	0.435	0.489	0.51	0.454		Х	0.313	0.305	0.330	0.330
В	Υ	0.375	0.470	0.475	0.377	Н	Υ	0.297	0.345	0.368	0.318
0	Х	0.342	0.460	0.489	0.435	,	Х	0.295	0.280	0.305	0.313
С	Υ	0.373	0.458	0.470	0.375		Υ	0.268	0.308	0.345	0.297
<u> </u>	Х	0.391	0.421	0.460	0.342		Х	0.281	0.260	0.280	0.295
D	Υ	0.363	0.436	0.458	0.373	J	Υ	0.242	0.270	0.308	0.268
Е	Х	0.375	0.392	0.421	0.391	V	Х	0.269	0.243	0.260	0.281
	Υ	0.353	0.419	0.436	0.363	K	Υ	0.220	0.232	0.270	0.242
F	Х	0.354	0.361	0.392	0.375	L	Х	0.250	0.225	0.243	0.269
	Υ	0.34	0.392	0.419	0.353		Υ	0.178	0.190	0.232	0.220

BIN	CCT (k)	BIN	CCT (k)	BIN	CCT (k)	BIN	CCT (k)
Α	2000-2500	В	2500-2750	С	2750-3000	D	3000-3500
E	3500-4000	F	4000-4600	G	4600-5700	Н	5700-7000
ı	7000-9000	J	9000-15000	К	15000-20000	L	20000-30000

*Measurement uncertainty of the coordinates:±0.01

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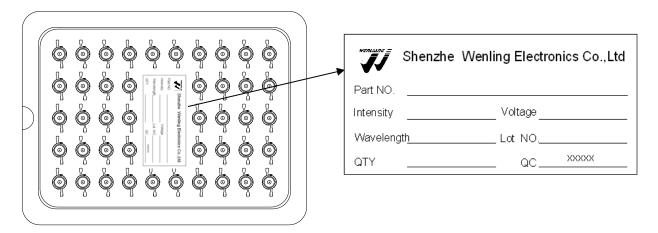
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Packing Specification

◆Anti-electrostatic bag



1. Storage

- 1. Do not open the moisture proof bag before the devices are ready to use.
- 2. Before the package is opened, LEDs should be stored at temperatures less than 30° C and humidity less than 90° .
 - 3. LEDs should be used within a year.
- 4. After the package is opened, LEDs should be stored at temperatures less than 30° C and humidity less than 60° K.
 - 5. LEDs should be used within 168 hours (7 days) after the package is opened.
- 6. If the moisture absorbent material (silicone gel) has faded away or LEDs have exceeded the storage time, baking treatment should be implemented based on the following conditions: pre-curing at 60 ± 5 °C for 24 hours.

2. Thermal Management

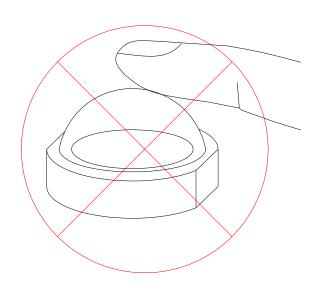
- 1). For maintaining the high flux output and achieving reliability, LEDs should be mounted on a metal core printed circuit board (MCPCB) or other kinds of heat sink with proper thermal connection to dissipate approximately 1W of thermal
 - 2). Don't reflow soldwer.
- 3). Sufficient thermal management must be implemented. Otherwise, the junction temperature of die may exceed over the limit at high current driving conditions and the LEDs' lifetime may be decrease dramatically.
- 4). For further thermal management suggestions, please consult the Wenliang Design Guide or local representatives for assistance.
- 5). Special thermal designs are also recommended to take in outer heat sink design, such as FR4 PCB on Aluminum with thermal vias or FPC on Aluminum with thermal conductive adhesive, etc.

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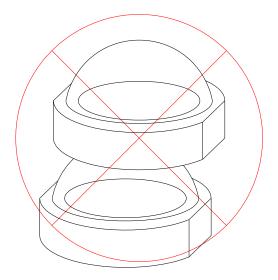
PAGE: 8/9 CHECKED:

3. Proper Handling

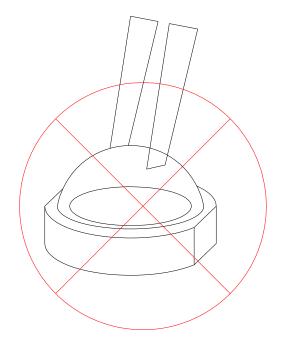
Please do not touch leds as four pictures listed below.



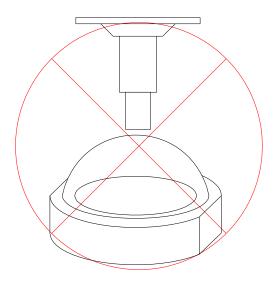
Do not press on the resin directly.



Do not stack the led together.



Do not touch the resin.



Avoid directly contacting with nozzle.